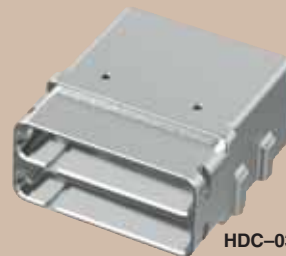


(0,635 mm) .025"

HDI6-035-01-RA-TR



HDC-035-01

HDI6, HDC SERIES

HIGH DENSITY HIGH SPEED I/O SYSTEM

Mates with:
HDLSP

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?HDI6

Insulator Material: Black LCP

Terminal Material:

Phosphor Bronze

Plating:

Au or Sn over 50µ" (1,27 µm) Ni

Current Rating:

1.5 A per pin

(4 adjacent pins powered)

Operating Temp Range:

-25°C to +105°C

Voltage Rating: 150 VAC

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



Note: Patented

Note: For HT3.1 see www.samtec.com/ht3 and specify part number ASP-149117-01

Note: Some lengths, styles and options are non-standard, non-returnable.

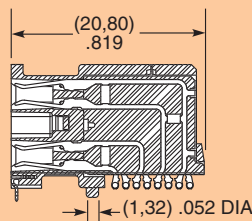
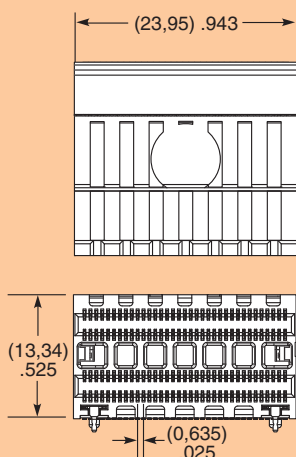
HDI6

NO. OF
POSITIONS

01

RA

TR

-035
(Per Row)-TR
= Tape & Reel Packaging

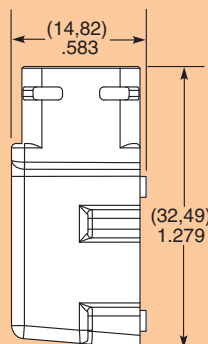
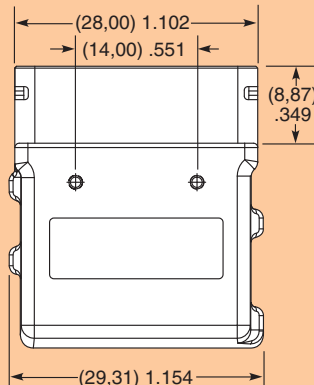
SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?HDC

TYPE

NO. OF
POSITIONS

01

HDC
= Cage-035
= Number of Positions

Note: For HT3.1 see www.samtec.com/ht3 and specify part number ASP-149118-01

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM